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Understanding Embedded - CPLDs (Complex Programmable Logic Devices)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

| Details | |
|---------------------------------|--|
| Product Status | Obsolete |
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 7.5 ns |
| Voltage Supply - Internal | 4.75V ~ 5.25V |
| Number of Logic Elements/Blocks | 8 |
| Number of Macrocells | 128 |
| Number of Gates | 2500 |
| Number of I/O | 100 |
| Operating Temperature | 0°C ~ 70°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 160-BQFP |
| Supplier Device Package | 160-PQFP (28x28) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/epm7128sqc160-7 |
| | |

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The MAX 7000E devices—including the EPM7128E, EPM7160E, EPM7192E, and EPM7256E devices—have several enhanced features: additional global clocking, additional output enable controls, enhanced interconnect resources, fast input registers, and a programmable slew rate.

In-system programmable MAX 7000 devices—called MAX 7000S devices—include the EPM7032S, EPM7064S, EPM7128S, EPM7160S, EPM7192S, and EPM7256S devices. MAX 7000S devices have the enhanced features of MAX 7000E devices as well as JTAG BST circuitry in devices with 128 or more macrocells, ISP, and an open-drain output option. See Table 4.

| Table 4. MAX 7000 Device Features | | | | | | |
|-----------------------------------|-------------------------------|-----------------------------|-----------------------------|--|--|--|
| Feature | EPM7032 EPM7064 EPM7096 | All MAX 7000E Devices | All MAX 7000S Devices | | | |
| ISP via JTAG interface | | | ✓ | | | |
| JTAG BST circuitry | | | √ (1) | | | |
| Open-drain output option | | | ✓ | | | |
| Fast input registers | | ✓ | ✓ | | | |
| Six global output enables | | ✓ | ✓ | | | |
| Two global clocks | | ✓ | ✓ | | | |
| Slew-rate control | | ✓ | ✓ | | | |
| MultiVolt interface (2) | ✓ | ✓ | ✓ | | | |
| Programmable register | ✓ | ✓ | ✓ | | | |
| Parallel expanders | ✓ | ✓ | ✓ | | | |
| Shared expanders | ✓ | ✓ | ✓ | | | |
| Power-saving mode | ✓ | ✓ | ✓ | | | |
| Security bit | ✓ | ✓ | ✓ | | | |
| PCI-compliant devices available | ✓ | ✓ | ✓ | | | |

Notes:

- (1) Available only in EPM7128S, EPM7160S, EPM7192S, and EPM7256S devices only.
- (2) The MultiVolt I/O interface is not available in 44-pin packages.

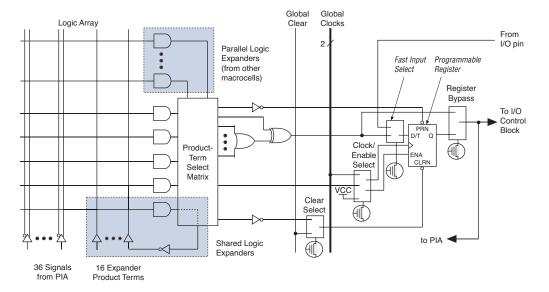
Each LAB is fed by the following signals:

- 36 signals from the PIA that are used for general logic inputs
- Global controls that are used for secondary register functions
- Direct input paths from I/O pins to the registers that are used for fast setup times for MAX 7000E and MAX 7000S devices

Macrocells

The MAX 7000 macrocell can be individually configured for either sequential or combinatorial logic operation. The macrocell consists of three functional blocks: the logic array, the product-term select matrix, and the programmable register. The macrocell of EPM7032, EPM7064, and EPM7096 devices is shown in Figure 3.

Figure 3. EPM7032, EPM7064 & EPM7096 Device Macrocell



Each programmable register can be clocked in three different modes:

- By a global clock signal. This mode achieves the fastest clock-tooutput performance.
- By a global clock signal and enabled by an active-high clock enable. This mode provides an enable on each flipflop while still achieving the fast clock-to-output performance of the global clock.
- By an array clock implemented with a product term. In this mode, the flipflop can be clocked by signals from buried macrocells or I/O pins.

In EPM7032, EPM7064, and EPM7096 devices, the global clock signal is available from a dedicated clock pin, GCLK1, as shown in Figure 1. In MAX 7000E and MAX 7000S devices, two global clock signals are available. As shown in Figure 2, these global clock signals can be the true or the complement of either of the global clock pins, GCLK1 or GCLK2.

Each register also supports asynchronous preset and clear functions. As shown in Figures 3 and 4, the product-term select matrix allocates product terms to control these operations. Although the product-term-driven preset and clear of the register are active high, active-low control can be obtained by inverting the signal within the logic array. In addition, each register clear function can be individually driven by the active-low dedicated global clear pin (GCLRn). Upon power-up, each register in the device will be set to a low state.

All MAX 7000E and MAX 7000S I/O pins have a fast input path to a macrocell register. This dedicated path allows a signal to bypass the PIA and combinatorial logic and be driven to an input D flipflop with an extremely fast (2.5 ns) input setup time.

Expander Product Terms

Although most logic functions can be implemented with the five product terms available in each macrocell, the more complex logic functions require additional product terms. Another macrocell can be used to supply the required logic resources; however, the MAX 7000 architecture also allows both shareable and parallel expander product terms ("expanders") that provide additional product terms directly to any macrocell in the same LAB. These expanders help ensure that logic is synthesized with the fewest possible logic resources to obtain the fastest possible speed.

When the tri-state buffer control is connected to ground, the output is tri-stated (high impedance) and the I/O pin can be used as a dedicated input. When the tri-state buffer control is connected to V_{CC} , the output is enabled.

The MAX 7000 architecture provides dual I/O feedback, in which macrocell and pin feedbacks are independent. When an I/O pin is configured as an input, the associated macrocell can be used for buried logic.

In-System Programmability (ISP)

MAX 7000S devices are in-system programmable via an industry-standard 4-pin Joint Test Action Group (JTAG) interface (IEEE Std. 1149.1-1990). ISP allows quick, efficient iterations during design development and debugging cycles. The MAX 7000S architecture internally generates the high programming voltage required to program EEPROM cells, allowing in-system programming with only a single 5.0 V power supply. During in-system programming, the I/O pins are tri-stated and pulled-up to eliminate board conflicts. The pull-up value is nominally 50 k%.

ISP simplifies the manufacturing flow by allowing devices to be mounted on a printed circuit board with standard in-circuit test equipment before they are programmed. MAX 7000S devices can be programmed by downloading the information via in-circuit testers (ICT), embedded processors, or the Altera MasterBlaster, ByteBlasterMV, ByteBlaster, BitBlaster download cables. (The ByteBlaster cable is obsolete and is replaced by the ByteBlasterMV cable, which can program and configure 2.5-V, 3.3-V, and 5.0-V devices.) Programming the devices after they are placed on the board eliminates lead damage on high-pin-count packages (e.g., QFP packages) due to device handling and allows devices to be reprogrammed after a system has already shipped to the field. For example, product upgrades can be performed in the field via software or modem.

In-system programming can be accomplished with either an adaptive or constant algorithm. An adaptive algorithm reads information from the unit and adapts subsequent programming steps to achieve the fastest possible programming time for that unit. Because some in-circuit testers cannot support an adaptive algorithm, Altera offers devices tested with a constant algorithm. Devices tested to the constant algorithm have an "F" suffix in the ordering code.

The JamTM Standard Test and Programming Language (STAPL) can be used to program MAX 7000S devices with in-circuit testers, PCs, or embedded processor.

Programming Times

The time required to implement each of the six programming stages can be broken into the following two elements:

- A pulse time to erase, program, or read the EEPROM cells.
- A shifting time based on the test clock (TCK) frequency and the number of TCK cycles to shift instructions, address, and data into the device.

By combining the pulse and shift times for each of the programming stages, the program or verify time can be derived as a function of the TCK frequency, the number of devices, and specific target device(s). Because different ISP-capable devices have a different number of EEPROM cells, both the total fixed and total variable times are unique for a single device.

Programming a Single MAX 7000S Device

The time required to program a single MAX 7000S device in-system can be calculated from the following formula:

$$t_{PROG} = t_{PPULSE} + \frac{Cycle_{PTCK}}{f_{TCK}}$$

where: t_{PROG} = Programming time t_{PPULSE} = Sum of the fixed times to erase, program, and

verify the EEPROM cells

 $Cycle_{PTCK}$ = Number of TCK cycles to program a device

= TCK frequency

The ISP times for a stand-alone verification of a single MAX 7000S device can be calculated from the following formula:

$$t_{VER} = t_{VPULSE} + \frac{Cycle_{VTCK}}{f_{TCK}}$$

where: t_{VER} = Verify time

 t_{VPULSE} = Sum of the fixed times to verify the EEPROM cells

 $Cycle_{VTCK}$ = Number of TCK cycles to verify a device

The programming times described in Tables 6 through 8 are associated with the worst-case method using the enhanced ISP algorithm.

| Table 6. MAX 7000S t _{PU} | ble 6. MAX 7000S t _{PULSE} & Cycle _{TCK} Values | | | | | | | | |
|------------------------------------|---|-----------------------|-------------------------|-----------------------|--|--|--|--|--|
| Device | Progra | ımming | Stand-Alone | Verification | | | | | |
| | t _{PPULSE} (s) | Cycle _{PTCK} | t _{VPULSE} (s) | Cycle _{VTCK} | | | | | |
| EPM7032S | 4.02 | 342,000 | 0.03 | 200,000 | | | | | |
| EPM7064S | 4.50 | 504,000 | 0.03 | 308,000 | | | | | |
| EPM7128S | 5.11 | 832,000 | 0.03 | 528,000 | | | | | |
| EPM7160S | 5.35 | 1,001,000 | 0.03 | 640,000 | | | | | |
| EPM7192S | 5.71 | 1,192,000 | 0.03 | 764,000 | | | | | |
| EPM7256S | 6.43 | 1,603,000 | 0.03 | 1,024,000 | | | | | |

Tables 7 and 8 show the in-system programming and stand alone verification times for several common test clock frequencies.

| Table 7. MAX 7000S In-System Programming Times for Different Test Clock Frequencies | | | | | | | | | |
|---|--------|------------------|-------|-------|---------|---------|---------|--------|-------|
| Device | | f _{TCK} | | | | | | | Units |
| | 10 MHz | 5 MHz | 2 MHz | 1 MHz | 500 kHz | 200 kHz | 100 kHz | 50 kHz | |
| EPM7032S | 4.06 | 4.09 | 4.19 | 4.36 | 4.71 | 5.73 | 7.44 | 10.86 | s |
| EPM7064S | 4.55 | 4.60 | 4.76 | 5.01 | 5.51 | 7.02 | 9.54 | 14.58 | S |
| EPM7128S | 5.19 | 5.27 | 5.52 | 5.94 | 6.77 | 9.27 | 13.43 | 21.75 | S |
| EPM7160S | 5.45 | 5.55 | 5.85 | 6.35 | 7.35 | 10.35 | 15.36 | 25.37 | S |
| EPM7192S | 5.83 | 5.95 | 6.30 | 6.90 | 8.09 | 11.67 | 17.63 | 29.55 | S |
| EPM7256S | 6.59 | 6.75 | 7.23 | 8.03 | 9.64 | 14.45 | 22.46 | 38.49 | S |

| Table 8. MAX 7000S Stand-Alone Verification Times for Different Test Clock Frequencies | | | | | | | | | |
|--|--------|------------------|-------|-------|---------|---------|---------|--------|-------|
| Device | | f _{TCK} | | | | | | | Units |
| | 10 MHz | 5 MHz | 2 MHz | 1 MHz | 500 kHz | 200 kHz | 100 kHz | 50 kHz | |
| EPM7032S | 0.05 | 0.07 | 0.13 | 0.23 | 0.43 | 1.03 | 2.03 | 4.03 | s |
| EPM7064S | 0.06 | 0.09 | 0.18 | 0.34 | 0.64 | 1.57 | 3.11 | 6.19 | S |
| EPM7128S | 0.08 | 0.14 | 0.29 | 0.56 | 1.09 | 2.67 | 5.31 | 10.59 | S |
| EPM7160S | 0.09 | 0.16 | 0.35 | 0.67 | 1.31 | 3.23 | 6.43 | 12.83 | S |
| EPM7192S | 0.11 | 0.18 | 0.41 | 0.79 | 1.56 | 3.85 | 7.67 | 15.31 | S |
| EPM7256S | 0.13 | 0.24 | 0.54 | 1.06 | 2.08 | 5.15 | 10.27 | 20.51 | S |

The instruction register length of MAX 7000S devices is 10 bits. Tables 10 and 11 show the boundary-scan register length and device IDCODE information for MAX 7000S devices.

| Table 10. MAX 7000S Boundary-Scan Register Length | | | | | | |
|---|-------------------------------|--|--|--|--|--|
| Device | Boundary-Scan Register Length | | | | | |
| EPM7032S | 1 (1) | | | | | |
| EPM7064S | 1 (1) | | | | | |
| EPM7128S | 288 | | | | | |
| EPM7160S | 312 | | | | | |
| EPM7192S | 360 | | | | | |
| EPM7256S | 480 | | | | | |

Note:

(1) This device does not support JTAG boundary-scan testing. Selecting either the EXTEST or SAMPLE/PRELOAD instruction will select the one-bit bypass register.

| Table 11. 32-Bit MAX 7000 Device IDCODE Note (1) | | | | | | | | |
|--|---------------------|-----------------------|--------------------------------------|------------------|--|--|--|--|
| Device | | IDCODE (32 Bits) | | | | | | |
| | Version (4 Bits) | Part Number (16 Bits) | Manufacturer's Identity (11 Bits) | 1 (1 Bit) (2) | | | | |
| EPM7032S | 0000 | 0111 0000 0011 0010 | 00001101110 | 1 | | | | |
| EPM7064S | 0000 | 0111 0000 0110 0100 | 00001101110 | 1 | | | | |
| EPM7128S | 0000 | 0111 0001 0010 1000 | 00001101110 | 1 | | | | |
| EPM7160S | 0000 | 0111 0001 0110 0000 | 00001101110 | 1 | | | | |
| EPM7192S | 0000 | 0111 0001 1001 0010 | 00001101110 | 1 | | | | |
| EPM7256S | 0000 | 0111 0010 0101 0110 | 00001101110 | 1 | | | | |

Notes:

- (1) The most significant bit (MSB) is on the left.
- (2) The least significant bit (LSB) for all JTAG IDCODEs is 1.

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------------|--|--|-------------------------|--------------------------|------|
| V _{IH} | High-level input voltage | | 2.0 | V _{CCINT} + 0.5 | V |
| V _{IL} | Low-level input voltage | | -0.5 (8) | 0.8 | V |
| V _{OH} | 5.0-V high-level TTL output voltage | I _{OH} = -4 mA DC, V _{CCIO} = 4.75 V (10) | 2.4 | | V |
| | 3.3-V high-level TTL output voltage | I _{OH} = -4 mA DC, V _{CCIO} = 3.00 V (10) | 2.4 | | V |
| | 3.3-V high-level CMOS output voltage | $I_{OH} = -0.1 \text{ mA DC}, V_{CCIO} = 3.0 \text{ V} (10)$ | V _{CCIO} - 0.2 | | V |
| V _{OL} | 5.0-V low-level TTL output voltage | I _{OL} = 12 mA DC, V _{CCIO} = 4.75 V (11) | | 0.45 | V |
| | 3.3-V low-level TTL output voltage | I _{OL} = 12 mA DC, V _{CCIO} = 3.00 V (11) | | 0.45 | V |
| | 3.3-V low-level CMOS output voltage | $I_{OL} = 0.1 \text{ mA DC}, V_{CCIO} = 3.0 \text{ V}(11)$ | | 0.2 | V |
| lı | Leakage current of dedicated input pins | $V_I = -0.5 \text{ to } 5.5 \text{ V } (11)$ | -10 | 10 | μА |
| l _{OZ} | I/O pin tri-state output off-state current | $V_I = -0.5 \text{ to } 5.5 \text{ V } (11), (12)$ | -40 | 40 | μА |

| Table 1 | 6. MAX 7000 5.0-V Device Capa | ncitance: EPM7032, EPM7064 & EPM7 | 7096 Devices | Note (1 | 3) |
|------------------|-------------------------------|-------------------------------------|--------------|---------|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| C _{IN} | Input pin capacitance | V _{IN} = 0 V, f = 1.0 MHz | | 12 | pF |
| C _{I/O} | I/O pin capacitance | V _{OUT} = 0 V, f = 1.0 MHz | | 12 | pF |

| Table 1 | 7. MAX 7000 5.0-V Device Capa | acitance: MAX 7000E Devices Note | (13) | | |
|------------------|-------------------------------|-------------------------------------|------|-----|------|
| Symbol | Parameter | Conditions | Min | Max | Unit |
| C _{IN} | Input pin capacitance | V _{IN} = 0 V, f = 1.0 MHz | | 15 | pF |
| C _{I/O} | I/O pin capacitance | V _{OUT} = 0 V, f = 1.0 MHz | | 15 | pF |

| Table 1 | Table 18. MAX 7000 5.0-V Device Capacitance: MAX 7000S DevicesNote (13) | | | | | |
|------------------|---|-------------------------------------|--|-----|------|--|
| Symbol | Symbol Parameter Conditions | | | Max | Unit | |
| C _{IN} | Dedicated input pin capacitance | V _{IN} = 0 V, f = 1.0 MHz | | 10 | pF | |
| C _{I/O} | I/O pin capacitance | V _{OUT} = 0 V, f = 1.0 MHz | | 10 | pF | |

Notes to tables:

- (1) See the Operating Requirements for Altera Devices Data Sheet.
- (2) Minimum DC input voltage on I/O pins is –0.5 V and on 4 dedicated input pins is –0.3 V. During transitions, the inputs may undershoot to –2.0 V or overshoot to 7.0 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) Numbers in parentheses are for industrial-temperature-range devices.
- (4) V_{CC} must rise monotonically.
- (5) The POR time for all 7000S devices does not exceed 300 μs. The sufficient V_{CCINT} voltage level for POR is 4.5 V. The device is fully initialized within the POR time after V_{CCINT} reaches the sufficient POR voltage level.
- (6) 3.3-V I/O operation is not available for 44-pin packages.
- (7) The V_{CCISP} parameter applies only to MAX 7000S devices.
- (8) During in-system programming, the minimum DC input voltage is –0.3 V.
- (9) These values are specified under the MAX 7000 recommended operating conditions in Table 14 on page 26.
- (10) The parameter is measured with 50% of the outputs each sourcing the specified current. The I_{OH} parameter refers to high-level TTL or CMOS output current.
- (11) The parameter is measured with 50% of the outputs each sinking the specified current. The I_{OL} parameter refers to low-level TTL, PCI, or CMOS output current.
- (12) When the JTAG interface is enabled in MAX 7000S devices, the input leakage current on the JTAG pins is typically -60 uA.
- (13) Capacitance is measured at 25° C and is sample-tested only. The OE1 pin has a maximum capacitance of 20 pF.

Figure 11 shows the typical output drive characteristics of MAX 7000 devices.

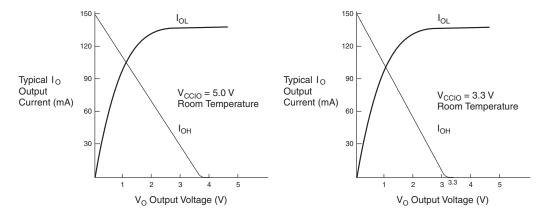
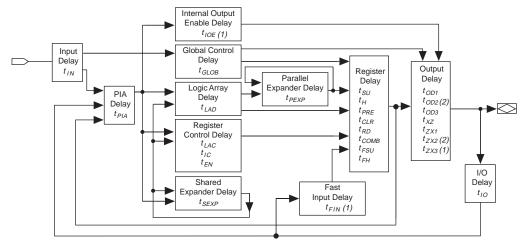


Figure 11. Output Drive Characteristics of 5.0-V MAX 7000 Devices

Timing Model

MAX 7000 device timing can be analyzed with the Altera software, with a variety of popular industry-standard EDA simulators and timing analyzers, or with the timing model shown in Figure 12. MAX 7000 devices have fixed internal delays that enable the designer to determine the worst-case timing of any design. The Altera software provides timing simulation, point-to-point delay prediction, and detailed timing analysis for a device-wide performance evaluation.

Figure 12. MAX 7000 Timing Model



Notes:

- (1) Only available in MAX 7000E and MAX 7000S devices.
- Not available in 44-pin devices.

The timing characteristics of any signal path can be derived from the timing model and parameters of a particular device. External timing parameters, which represent pin-to-pin timing delays, can be calculated as the sum of internal parameters. Figure 13 shows the internal timing relationship of internal and external delay parameters.



For more infomration, see *Application Note* 94 (Understanding MAX 7000 *Timing*).

Tables 19 through 26 show the MAX 7000 and MAX 7000E AC operating conditions.

| Symbol | Parameter | Conditions | -6 Spee | d Grade | -7 Speed Grade | | Unit |
|-------------------|--|----------------|---------|---------|----------------|-----|------|
| | | | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 6.0 | | 7.5 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 6.0 | | 7.5 | ns |
| t _{SU} | Global clock setup time | | 5.0 | | 6.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | (2) | 2.5 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | (2) | 0.5 | | 0.5 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 4.0 | | 4.5 | ns |
| t _{CH} | Global clock high time | | 2.5 | | 3.0 | | ns |
| t _{CL} | Global clock low time | | 2.5 | | 3.0 | | ns |
| t _{ASU} | Array clock setup time | | 2.5 | | 3.0 | | ns |
| t _{AH} | Array clock hold time | | 2.0 | | 2.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 6.5 | | 7.5 | ns |
| t _{ACH} | Array clock high time | | 3.0 | | 3.0 | | ns |
| t _{ACL} | Array clock low time | | 3.0 | | 3.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 3.0 | | 3.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 6.6 | | 8.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (5) | 151.5 | | 125.0 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 6.6 | | 8.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (5) | 151.5 | | 125.0 | | MHz |
| f _{MAX} | Maximum clock frequency | (6) | 200 | | 166.7 | | MHz |

| Table 2 | 21. MAX 7000 & MAX 7000E Ext | ernal Timing Param | eters Note | (1) | | | | | | |
|-------------------|--|--------------------|------------|-------------|--------|------|-----|--|--|--|
| Symbol | Parameter | Conditions | | Speed Grade | | | | | | |
| | | | MAX 700 | OE (-10P) | MAX 70 | | | | | |
| | | | Min | Max | Min | Max | | | | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 10.0 | | 10.0 | ns | | | |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 10.0 | | 10.0 | ns | | | |
| t _{SU} | Global clock setup time | | 7.0 | | 8.0 | | ns | | | |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | ns | | | |
| t _{FSU} | Global clock setup time of fast input | (2) | 3.0 | | 3.0 | | ns | | | |
| t _{FH} | Global clock hold time of fast input | (2) | 0.5 | | 0.5 | | ns | | | |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 5.0 | | 5 | ns | | | |
| t _{CH} | Global clock high time | | 4.0 | | 4.0 | | ns | | | |
| t _{CL} | Global clock low time | | 4.0 | | 4.0 | | ns | | | |
| t _{ASU} | Array clock setup time | | 2.0 | | 3.0 | | ns | | | |
| t _{AH} | Array clock hold time | | 3.0 | | 3.0 | | ns | | | |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 10.0 | | 10.0 | ns | | | |
| t _{ACH} | Array clock high time | | 4.0 | | 4.0 | | ns | | | |
| t _{ACL} | Array clock low time | | 4.0 | | 4.0 | | ns | | | |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 4.0 | | 4.0 | | ns | | | |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | ns | | | |
| t _{CNT} | Minimum global clock period | | | 10.0 | | 10.0 | ns | | | |
| f _{CNT} | Maximum internal global clock frequency | (5) | 100.0 | | 100.0 | | MHz | | | |
| t _{ACNT} | Minimum array clock period | | | 10.0 | | 10.0 | ns | | | |
| f _{ACNT} | Maximum internal array clock frequency | (5) | 100.0 | | 100.0 | | MHz | | | |
| f _{MAX} | Maximum clock frequency | (6) | 125.0 | | 125.0 | | MHz | | | |

| Table 2 | 23. MAX 7000 & MAX 7000E Ext | ernal Timing Param | eters Note | e (1) | | | |
|-------------------|--|--------------------|-------------------|-----------|--------|------|------|
| Symbol | Parameter | Conditions | | Speed | Grade | | Unit |
| | | | MAX 700 | 0E (-12P) | MAX 70 | - | |
| | | | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 12.0 | | 12.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 12.0 | | 12.0 | ns |
| t _{SU} | Global clock setup time | | 7.0 | | 10.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | (2) | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | (2) | 0.0 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 6.0 | | 6.0 | ns |
| t _{CH} | Global clock high time | | 4.0 | | 4.0 | | ns |
| t _{CL} | Global clock low time | | 4.0 | | 4.0 | | ns |
| t _{ASU} | Array clock setup time | | 3.0 | | 4.0 | | ns |
| t _{AH} | Array clock hold time | | 4.0 | | 4.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 12.0 | | 12.0 | ns |
| t _{ACH} | Array clock high time | | 5.0 | | 5.0 | | ns |
| t _{ACL} | Array clock low time | | 5.0 | | 5.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (3) | 5.0 | | 5.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 11.0 | | 11.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (5) | 90.9 | | 90.9 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 11.0 | | 11.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (5) | 90.9 | | 90.9 | | MHz |
| f _{MAX} | Maximum clock frequency | (6) | 125.0 | | 125.0 | | MHz |

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | |
|-------------------|--|----------------|-------------|------|------|------|-----|------|----|--|
| | | | -15 | | -15T | | -20 | | | |
| | | | Min | Max | Min | Max | Min | Max | | |
| t _{IN} | Input pad and buffer delay | | | 2.0 | | 2.0 | | 3.0 | ns | |
| t _{IO} | I/O input pad and buffer delay | | | 2.0 | | 2.0 | | 3.0 | ns | |
| t _{FIN} | Fast input delay | (2) | | 2.0 | | _ | | 4.0 | ns | |
| t _{SEXP} | Shared expander delay | | | 8.0 | | 10.0 | | 9.0 | ns | |
| t _{PEXP} | Parallel expander delay | | | 1.0 | | 1.0 | | 2.0 | ns | |
| t _{LAD} | Logic array delay | | | 6.0 | | 6.0 | | 8.0 | ns | |
| t _{LAC} | Logic control array delay | | | 6.0 | | 6.0 | | 8.0 | ns | |
| t _{IOE} | Internal output enable delay | (2) | | 3.0 | | _ | | 4.0 | ns | |
| t _{OD1} | Output buffer and pad delay Slow slew rate = off V _{CCIO} = 5.0 V | C1 = 35 pF | | 4.0 | | 4.0 | | 5.0 | ns | |
| t _{OD2} | Output buffer and pad delay Slow slew rate = off V _{CCIO} = 3.3 V | C1 = 35 pF (7) | | 5.0 | | - | | 6.0 | ns | |
| t _{OD3} | Output buffer and pad delay Slow slew rate = on V _{CCIO} = 5.0 V or 3.3 V | C1 = 35 pF (2) | | 8.0 | | - | | 9.0 | ns | |
| t _{ZX1} | Output buffer enable delay Slow slew rate = off V _{CCIO} = 5.0 V | C1 = 35 pF | | 6.0 | | 6.0 | | 10.0 | ns | |
| t _{ZX2} | Output buffer enable delay Slow slew rate = off V _{CCIO} = 3.3 V | C1 = 35 pF (7) | | 7.0 | | - | | 11.0 | ns | |
| t _{ZX3} | Output buffer enable delay Slow slew rate = on V _{CCIO} = 5.0 V or 3.3 V | C1 = 35 pF (2) | | 10.0 | | - | | 14.0 | ns | |
| t_{XZ} | Output buffer disable delay | C1 = 5 pF | | 6.0 | | 6.0 | | 10.0 | ns | |
| t _{SU} | Register setup time | | 4.0 | | 4.0 | | 4.0 | | ns | |
| t _H | Register hold time | | 4.0 | | 4.0 | | 5.0 | | ns | |
| t _{FSU} | Register setup time of fast input | (2) | 2.0 | | - | | 4.0 | | ns | |
| t _{FH} | Register hold time of fast input | (2) | 2.0 | | - | | 3.0 | | ns | |
| t _{RD} | Register delay | | | 1.0 | | 1.0 | | 1.0 | ns | |
| t _{COMB} | Combinatorial delay | | | 1.0 | | 1.0 | | 1.0 | ns | |
| t _{IC} | Array clock delay | | | 6.0 | | 6.0 | | 8.0 | ns | |
| t _{EN} | Register enable time | | | 6.0 | | 6.0 | | 8.0 | ns | |
| t _{GLOB} | Global control delay | | | 1.0 | | 1.0 | | 3.0 | ns | |
| t _{PRE} | Register preset time | | | 4.0 | | 4.0 | | 4.0 | ns | |
| t _{CLR} | Register clear time | | | 4.0 | | 4.0 | | 4.0 | ns | |
| t _{PIA} | PIA delay | | | 2.0 | | 2.0 | | 3.0 | ns | |
| t _{LPA} | Low-power adder | (8) | | 13.0 | | 15.0 | | 15.0 | ns | |

| Table 2 | Table 27. EPM7032S External Timing Parameters (Part 2 of 2) Note (1) | | | | | | | | | | |
|-------------------|---|------------|---------------------|--------------|-------|-----|-------|-----|-------|------|-----|
| Symbol | Parameter | Conditions | ions Speed Grade Un | | | | | | | Unit | |
| | | | - | -5 -6 -7 -10 | | | | | | 10 | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| f _{ACNT} | Maximum internal array clock frequency | (4) | 175.4 | | 142.9 | | 116.3 | | 100.0 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 250.0 | | 200.0 | | 166.7 | | 125.0 | | MHz |

| Table 2 | Table 28. EPM7032S Internal Timing Parameters Note (1) | | | | | | | | | | |
|-------------------|--|----------------|-------------|-----|-----|-----|-----|-----|-----|-----|------|
| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
| | | | - | 5 | - | 6 | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t _{IN} | Input pad and buffer delay | | | 0.2 | | 0.2 | | 0.3 | | 0.5 | ns |
| t _{IO} | I/O input pad and buffer delay | | | 0.2 | | 0.2 | | 0.3 | | 0.5 | ns |
| t _{FIN} | Fast input delay | | | 2.2 | | 2.1 | | 2.5 | | 1.0 | ns |
| t _{SEXP} | Shared expander delay | | | 3.1 | | 3.8 | | 4.6 | | 5.0 | ns |
| t _{PEXP} | Parallel expander delay | | | 0.9 | | 1.1 | | 1.4 | | 0.8 | ns |
| t _{LAD} | Logic array delay | | | 2.6 | | 3.3 | | 4.0 | | 5.0 | ns |
| t _{LAC} | Logic control array delay | | | 2.5 | | 3.3 | | 4.0 | | 5.0 | ns |
| t _{IOE} | Internal output enable delay | | | 0.7 | | 0.8 | | 1.0 | | 2.0 | ns |
| t _{OD1} | Output buffer and pad delay | C1 = 35 pF | | 0.2 | | 0.3 | | 0.4 | | 1.5 | ns |
| t _{OD2} | Output buffer and pad delay | C1 = 35 pF (6) | | 0.7 | | 0.8 | | 0.9 | | 2.0 | ns |
| t _{OD3} | Output buffer and pad delay | C1 = 35 pF | | 5.2 | | 5.3 | | 5.4 | | 5.5 | ns |
| t _{ZX1} | Output buffer enable delay | C1 = 35 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t _{ZX2} | Output buffer enable delay | C1 = 35 pF (6) | | 4.5 | | 4.5 | | 4.5 | | 5.5 | ns |
| t _{ZX3} | Output buffer enable delay | C1 = 35 pF | | 9.0 | | 9.0 | | 9.0 | | 9.0 | ns |
| t _{XZ} | Output buffer disable delay | C1 = 5 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t _{SU} | Register setup time | | 0.8 | | 1.0 | | 1.3 | | 2.0 | | ns |
| t _H | Register hold time | | 1.7 | | 2.0 | | 2.5 | | 3.0 | | ns |
| t _{FSU} | Register setup time of fast input | | 1.9 | | 1.8 | | 1.7 | | 3.0 | | ns |
| t _{FH} | Register hold time of fast input | | 0.6 | | 0.7 | | 0.8 | | 0.5 | | ns |
| t _{RD} | Register delay | | | 1.2 | | 1.6 | | 1.9 | | 2.0 | ns |
| t _{COMB} | Combinatorial delay | | | 0.9 | | 1.1 | | 1.4 | | 2.0 | ns |
| t _{IC} | Array clock delay | | | 2.7 | | 3.4 | | 4.2 | | 5.0 | ns |
| t _{EN} | Register enable time | | | 2.6 | | 3.3 | | 4.0 | | 5.0 | ns |
| t _{GLOB} | Global control delay | | | 1.6 | | 1.4 | | 1.7 | | 1.0 | ns |
| t _{PRE} | Register preset time | | | 2.0 | | 2.4 | | 3.0 | | 3.0 | ns |
| t _{CLR} | Register clear time | | | 2.0 | | 2.4 | | 3.0 | | 3.0 | ns |

Tables 31 and 32 show the EPM7128S AC operating conditions.

| Table 3 | Table 31. EPM7128S External Timing Parameters Note (1) | | | | | | | | | | |
|-------------------|--|----------------|-------------|-----|-------|-----|-------|------|-------|------|------|
| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
| | | | - | 6 | -7 | | -10 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t _{PD1} | Input to non-registered output | C1 = 35 pF | | 6.0 | | 7.5 | | 10.0 | | 15.0 | ns |
| t _{PD2} | I/O input to non-registered output | C1 = 35 pF | | 6.0 | | 7.5 | | 10.0 | | 15.0 | ns |
| t _{SU} | Global clock setup time | | 3.4 | | 6.0 | | 7.0 | | 11.0 | | ns |
| t _H | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | 0.0 | | ns |
| t _{FSU} | Global clock setup time of fast input | | 2.5 | | 3.0 | | 3.0 | | 3.0 | | ns |
| t _{FH} | Global clock hold time of fast input | | 0.0 | | 0.5 | | 0.5 | | 0.0 | | ns |
| t _{CO1} | Global clock to output delay | C1 = 35 pF | | 4.0 | | 4.5 | | 5.0 | | 8.0 | ns |
| t _{CH} | Global clock high time | | 3.0 | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{CL} | Global clock low time | | 3.0 | | 3.0 | | 4.0 | | 5.0 | | ns |
| t _{ASU} | Array clock setup time | | 0.9 | | 3.0 | | 2.0 | | 4.0 | | ns |
| t _{AH} | Array clock hold time | | 1.8 | | 2.0 | | 5.0 | | 4.0 | | ns |
| t _{ACO1} | Array clock to output delay | C1 = 35 pF | | 6.5 | | 7.5 | | 10.0 | | 15.0 | ns |
| t _{ACH} | Array clock high time | | 3.0 | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ACL} | Array clock low time | | 3.0 | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{CPPW} | Minimum pulse width for clear and preset | (2) | 3.0 | | 3.0 | | 4.0 | | 6.0 | | ns |
| t _{ODH} | Output data hold time after clock | C1 = 35 pF (3) | 1.0 | | 1.0 | | 1.0 | | 1.0 | | ns |
| t _{CNT} | Minimum global clock period | | | 6.8 | | 8.0 | | 10.0 | | 13.0 | ns |
| f _{CNT} | Maximum internal global clock frequency | (4) | 147.1 | | 125.0 | | 100.0 | | 76.9 | | MHz |
| t _{ACNT} | Minimum array clock period | | | 6.8 | | 8.0 | | 10.0 | | 13.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (4) | 147.1 | | 125.0 | | 100.0 | | 76.9 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 166.7 | | 166.7 | | 125.0 | | 100.0 | | MHz |

Notes to tables:

- These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The f_{MAX} values represent the highest frequency for pipelined data.
- (6) Operating conditions: $V_{CCIO} = 3.3 \text{ V} \pm 10\%$ for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , $\mathbf{t_{ACL}}$, and $\mathbf{t_{CPPW}}$ parameters for macrocells running in the low-power mode.

Power Consumption

Supply power (P) versus frequency (f_{MAX} in MHz) for MAX 7000 devices is calculated with the following equation:

$$P = P_{INT} + P_{IO} = I_{CCINT} \times V_{CC} + P_{IO}$$

The P_{IO} value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in *Application Note* 74 (*Evaluating Power for Altera Devices*).

The I_{CCINT} value, which depends on the switching frequency and the application logic, is calculated with the following equation:

$$I_{CCINT} =$$

$$A \times MC_{TON} + B \times (MC_{DEV} - MC_{TON}) + C \times MC_{USED} \times f_{MAX} \times tog_{USED}$$

The parameters in this equation are shown below:

 MC_{TON} = Number of macrocells with the Turbo Bit option turned on,

as reported in the MAX+PLUS II Report File (.rpt)

 MC_{DEV} = Number of macrocells in the device

MC_{USED} = Total number of macrocells in the design, as reported

in the MAX+PLUS II Report File (.rpt)

 f_{MAX} = Highest clock frequency to the device

tog_{LC} = Average ratio of logic cells toggling at each clock

(typically 0.125)

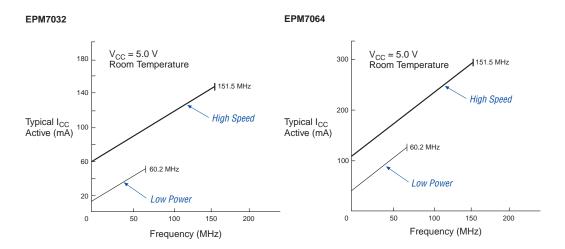
A, B, C = Constants, shown in Table 39

| Table 39. MAX 7000 I _{CC} Equation Constants | | | | | | | | | |
|---|------|------|-------|--|--|--|--|--|--|
| Device | Α | В | С | | | | | | |
| EPM7032 | 1.87 | 0.52 | 0.144 | | | | | | |
| EPM7064 | 1.63 | 0.74 | 0.144 | | | | | | |
| EPM7096 | 1.63 | 0.74 | 0.144 | | | | | | |
| EPM7128E | 1.17 | 0.54 | 0.096 | | | | | | |
| EPM7160E | 1.17 | 0.54 | 0.096 | | | | | | |
| EPM7192E | 1.17 | 0.54 | 0.096 | | | | | | |
| EPM7256E | 1.17 | 0.54 | 0.096 | | | | | | |
| EPM7032S | 0.93 | 0.40 | 0.040 | | | | | | |
| EPM7064S | 0.93 | 0.40 | 0.040 | | | | | | |
| EPM7128S | 0.93 | 0.40 | 0.040 | | | | | | |
| EPM7160S | 0.93 | 0.40 | 0.040 | | | | | | |
| EPM7192S | 0.93 | 0.40 | 0.040 | | | | | | |
| EPM7256S | 0.93 | 0.40 | 0.040 | | | | | | |

This calculation provides an I_{CC} estimate based on typical conditions using a pattern of a 16-bit, loadable, enabled, up/down counter in each LAB with no output load. Actual I_{CC} values should be verified during operation because this measurement is sensitive to the actual pattern in the device and the environmental operating conditions.

Figure 14 shows typical supply current versus frequency for MAX 7000 devices.

Figure 14. I_{CC} vs. Frequency for MAX 7000 Devices (Part 1 of 2)



EPM7096

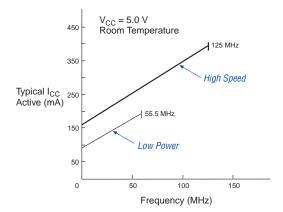
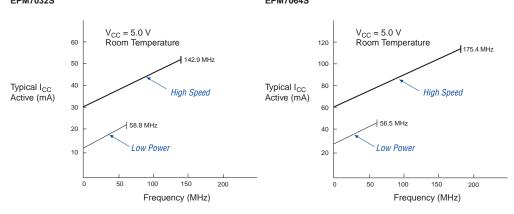


Figure 15 shows typical supply current versus frequency for MAX 7000S devices.





EPM7128S EPM7160S

